

P-Channel 60 V (D-S) 175 °C MOSFET

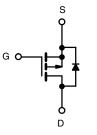
PRODUCT SUMMARY				
V _{DS} (V)	- 60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0135			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.017			
I _D (A)	- 50			
Configuration	Single			

TrenchFEPackage

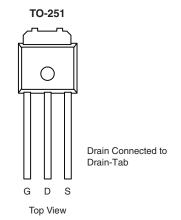
FEATURES

- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested





P-Channel MOSFET



ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current ^a	T _C = 25 °C	- I _D	- 50		
	T _C = 125 °C		- 38		
Continuous Source Current (Diode Conduction) ^a		I _S	- 50	Α	
Pulsed Drain Current ^b		I _{DM}	- 200		
Single Pulse Avalanche Current	. 0.4	I _{AS}	- 52		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	135	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	P_	136	W	
	T _C = 125 °C		45		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	50	°C/W
Junction-to-Case (Drain)		R_{thJC}	1.1	C/VV

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).



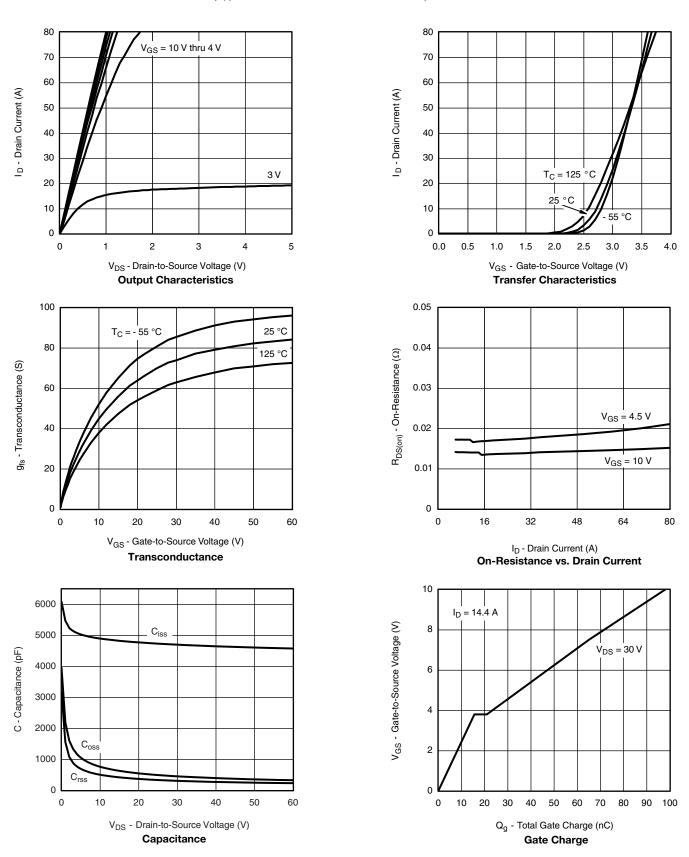
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = -250 \mu A$		-	- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 60 V	1	-	- 1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	- 50	μΑ
		V _{GS} = 0 V	V _{DS} = - 60 V, T _J = 175 °C	-	-	- 150	-
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	V _{DS} ≥ - 5 V	- 50	-	-	Α
		V _{GS} = - 10 V	I _D = - 17 A	-	0.0135	-	Ω
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V	I _D = - 50 A, T _J = 125 °C	-	0.026	-	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 50 A, T _J = 175 °C	-	0.032	-	
		V _{GS} = - 4.5 V	I _D = - 14 A	-	0.017	-	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 17 A		-	50	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{GS} = 0 V V _{DS} = - 25 V, f = 1 MHz	-	4730	5910	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	485	606	
Reverse Transfer Capacitance	C _{rss}			-	330	410	
Total Gate Charge ^c	Qg			-	98	150	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	$V_{DS} = -30 \text{ V}, I_{D} = -50 \text{ A}$	-	15	23	nC
Gate-Drain Charge ^c	Q _{gd}			-	21	32	
Gate Resistance	Rg	f = 1 MHz		1.47	2.9	4.42	Ω
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = -30 \text{ V}, \text{ R}_{L} = 0.6 \Omega$ $I_{D} \cong -50 \text{ A}, \text{ V}_{GEN} = -10 \text{ V}, \text{ R}_{g} = 6.0 \Omega$		-	15	18	
Rise Time ^c	t _r			-	12	16	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	112	125	
Fall Time ^c	t _f			-	39	48	
Source-Drain Diode Ratings and Char	acteristics ^b				•		
Pulsed Current ^a	I _{SM}			-	-	- 200	Α
Forward Voltage	V_{SD}	I _F = - 50 A, V _{GS} = 0 V			- 0.8	- 1.5	V

Notes

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

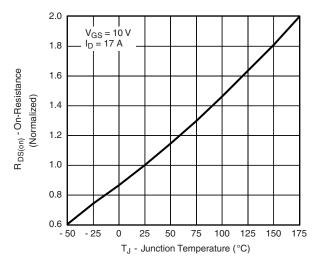


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

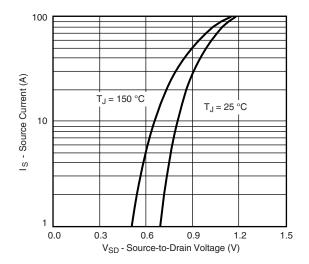




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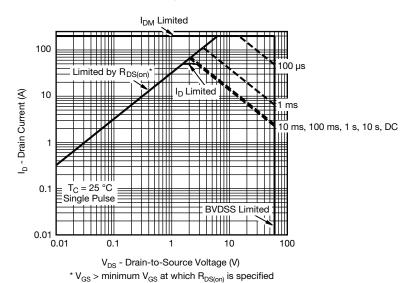






Source Drain Diode Forward Voltage

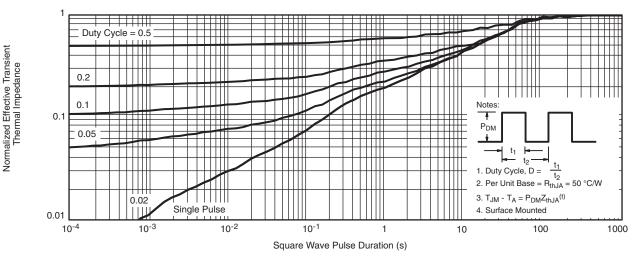
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



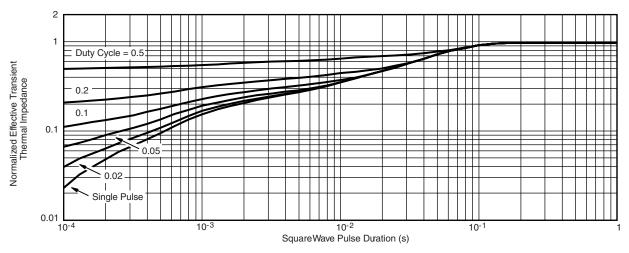
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C)

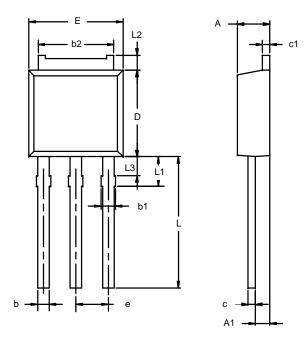
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

服务热线:400-655-8788

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TO-251AA



Note: Dimension L3 is for reference onl

	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28	BSC	0.090	BSC
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060



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